

MX23L4000

4M-BIT MASK ROM (8 BIT OUTPUT)

FEATURES

- Bit organization
- 512Kb x 8 (byte mode)
- Fast access time
 - Random access: 150ns (max.) for 2.7~3.6V
- Current
 - Operating: 20mA
- Standby: 20uA
- Supply voltage
 - 2.7V~3.6V
- Package
 - 32 pin SOP (450mil)
 - 32 pin TSOP (8mm x 20mm)

ORDER INFORMATION

Access Time	Package
150ns	32 pin SOP
	(Industrial)
200ns	32 pin SOP
	(Industrial)
150ns	32 pin TSOP
200ns	32 pin TSOP
150ns	32 pin TSOP
	(Industrial)
200ns	32 pin TSOP
	(Industrial)
	150ns 200ns 150ns 200ns 150ns

PIN CONFIGURATION

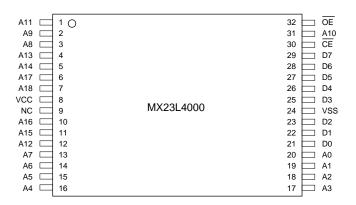
32 SOP

-				_
NC 🗆	0		32	□ vcc
A16 🗆	2		31	□ A18
A15 🗆	2		30	□ A17
A12 🗆	4		29	□ A14
A7 🗀	5		28	□ A13
A6 □	6	9	27	□ A8
A5 □	7	MX23L4000	26	□ A9
A4 🗖	8	7	25	□ A11
A3 🗀	9	8	24	□ Œ
A2 🗆	10	ŝ	23	□ A10
A1 🗖	11	_	22	□ CE
A0 🗆	12		21	□ D7
D0 🗆	13		10	□ D6
D1 🗆	14		19	□ D5
D2 🗆	15		18	□ D4
vss 🗆	16		17	□ D3
L				

PIN DESCRIPTION

Symbol	Pin Function
A0~A18	Address Inputs
D0~D7	Data Outputs
CE	Chip Enable Input
ŌĒ	Output Enable Input
VCC	Power Supply Pin
VSS	Ground Pin
NC	No Connection

32 TSOP





ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Ratings	
Voltage on any Pin Relative to VSS	VIN	-0.3V to 3.9V	
Ambient Operating Temperature	Topr	-40° C to 85° C	
Storage Temperature	Tstg	-65° C to 125° C	

DC CHARACTERISTICS (Ta = -40° C ~ 85° C, VCC = 2.7V~3.6V)

Item	Symbol	MIN.	MAX.	Conditions
Output High Voltage	VOH	VCC-0.2V	-	IOH = -0.4mA
Output Low Voltage	VOL	-	0.2V	IOL = 1.6mA
Input High Voltage	VIH	2.1V	VCC+0.3V	
Input Low Voltage	VIL	-0.3V	0.4V	
Input Leakage Current	ILI	-	10uA	0V, VCC
Output Leakage Current	ILO	-	10uA	0V, VCC
Operating Current	ICC1	-	20mA	f=5MHz, all output open
Standby Current (TTL)	ISTB1	-	1mA	CE=VIH
Standby Current (CMOS)	ISTB2	-	20uA	CE> VCC - 0.2V
Input Capacitance	CIN	-	10pF	Ta = 25° C, f = 1MHZ
Output Capacitance	COUT	-	10pF	Ta = 25° C, f = 1MHZ

AC CHARACTERISTICS (Ta = -40° C ~ 85° C, VCC = 2.7V~3.6V)

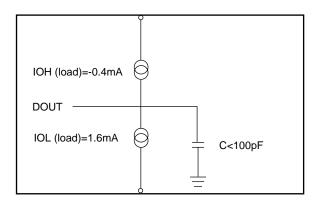
Item	Symbol	23L400	23L4000-15		00-20
		MIN.	MAX.	MIN.	MAX.
Read Cycle Time	tRC	150ns	-	200ns	-
Address Access Time	tAA	-	150ns	-	200ns
Chip Enable Access Time	tACE	-	150ns	-	200ns
Output Enable Time	tOE	-	70ns	-	100ns
Output Hold After Address	tOH	0ns	-	0ns	-
Output High Z Delay	tHZ	-	20ns	-	20ns

Note: Output high-impedance delay (tHZ) is measured from OE or CE going high, and this parameter guaranteed by design over the full voltage and temperature operating range - not tested.



AC Test Conditions

Input Pulse Levels	0.4V~2.4V
Input Rise and Fall Times	10ns
Input Timing Level	1.4V
Output Timing Level	1.4V
Output Load	See Figure



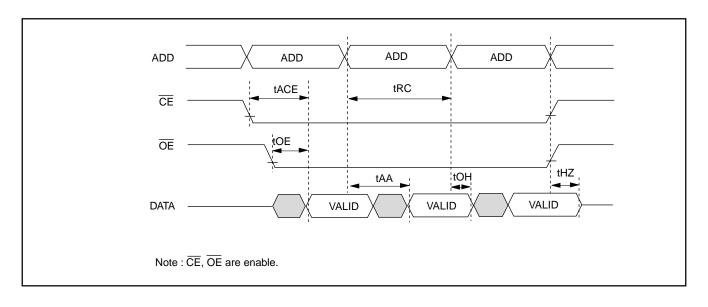
Note:No output loading is present in tester load board.

Active loading is used and under software programming control.

Output loading capacitance includes load board's and all stray capacitance.

TIMING DIAGRAM

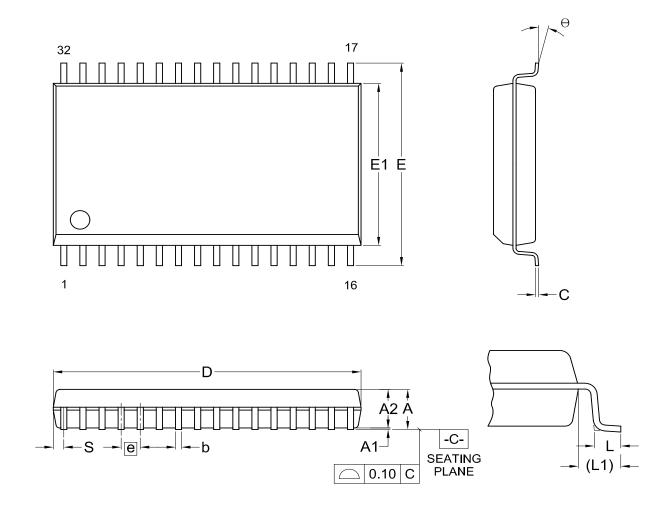
RANDOM READ





PACKAGE INFORMATION

Title: Package Outline for SOP 32L (450MIL)



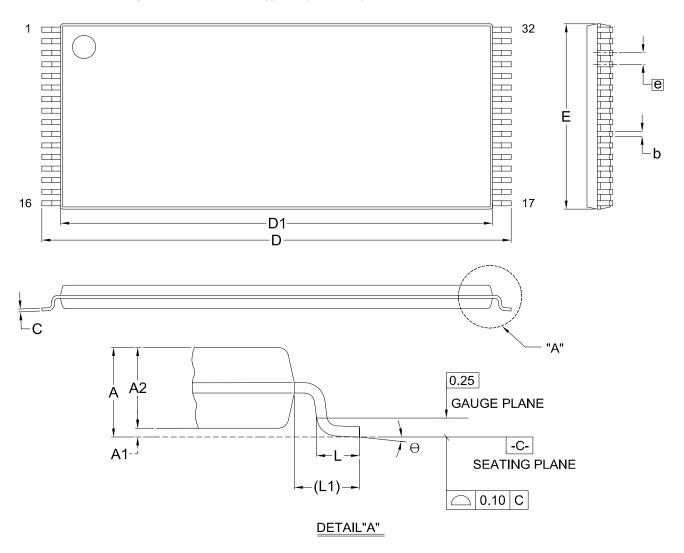
Dimensions (inch dimensions are derived from the original mm dimensions)

SY UNIT	MBOL	Α	A 1	A2	b	С	D	E	E1	е	L	L1	S	θ
	MIn.	1	0.10	2.59	0.36	0.15	20.32	13.92	11.18		0.56	1.20	0.58	0
mm	Nom.		0.15	2.69	0.41	0.20	20.45	14.12	11.30	1.27	0.76	1.40	0.70	5
	Max.	3.00	0.20	2.80	0.51	0.25	20.57	14.32	11.43		0.96	1.60	0.83	8
	Min.	-	0.004	0.102	0.014	0.006	0.800	0.548	0.440		0.022	0.047	0.023	0
Inch	Nom.	İ	0.006	0.106	0.016	0.008	0.805	0.556	0.445	0.050	0.030	0.055	0.028	5
	Max.	0.118	0.008	0.110	0.020	0.010	0.810	0.564	0.450		0.038	0.063	0.033	8

DWG.NO.	DEVISION		REFERENCE	ISSUE DATE
DWG.NO.	REVISION	JEDEC	EIAJ	1990E DATE
6110-1404	5	MO-099		11-26-'03



Title: Package Outline for TSOP(I) 32L (8X20mm)



Dimensions (inch dimensions are derived from the original mm dimensions)

SY UNIT	MBOL	Α	A 1	A2	b	С	D	D1	E	е	L	L1	Θ
	Min.		0.05	0.95	0.17	0.10	19.80	18.30	7.90		0.50	0.70	0
mm	Nom.		0.10	1.00	0.20	0.15	20.00	18.40	8.00	0.50	0.60	0.80	5
	Max.	1.20	0.15	1.05	0.27	0.21	20.20	18.50	8.10		0.70	0.90	8
	Min.		0.002	0.037	0.007	0.004	0.780	0.720	0.311		0.020	0.028	0
Inch	Nom.		0.004	0.039	0.008	0.006	0.787	0.724	0.315	0.020	0.024	0.031	5
	Max.	0.047	0.006	0.041	0.011	0.008	0.795	0.728	0.319		0.028	0.035	8

DWG.NO.	DEVISION		ISSUE DATE		
DWG.NO.	REVISION	JEDEC	EIAJ		1990E DATE
6110-1604	9	MO-142			11-26-'03





REVISION HISTORY

REVISION	DESCRIPTION	PAGE	DATE
1.4	AC CHARACTERISTICS tOH 25ns>0ns	P3	FEB/01/1999
1.5	1. To modify Absolute Maximum Ratings	P2	JUN/19/2001
	2. To modify DC Characteristics	P2	
	3. To modify Package Information	P4,5	
1.6	1. To modify Package Information	P4,5	NOV/22/2002



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